

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE60P20K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

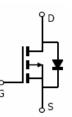
General Features

- V_{DS} =-60V,I_D =-20A
 - R_{DS(ON)} <42mΩ @ V_{GS}=-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!



Schematic diagram



Marking and pin assignment



TO-252-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE60P20K	NCE60P20K	TO-252-2L	-	-	-

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-60	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	Ι _D	-20	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	-14.1	А
Pulsed Drain Current	I _{DM}	80	A
Maximum Power Dissipation	PD	60	W
Derating factor		0.4	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	100	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C
Thermal Characteristic			
Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	2.5	°C/W



Electrical Characteristics (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	· ·					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-2	-2.8	-3.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-20A	-	35	42	mΩ
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-20A		20	-	S
Dynamic Characteristics (Note4)	· ·		•			
Input Capacitance	C _{lss}	V _{DS} =-30V,V _{GS} =0V, F=1.0MHz		2485	-	PF
Output Capacitance	C _{oss}			114	-	PF
Reverse Transfer Capacitance	C _{rss}			104	-	PF
Switching Characteristics (Note 4)	· ·					
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	tr	V _{DD} =-30V,I _D =-20A	-	14	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =3 Ω	-	38	-	nS
Turn-Off Fall Time	t _f		-	15	-	nS
Total Gate Charge	Qg	V = 20V/L = 20A	-	46.1	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-30V,I _D =-20A, V _{GS} =-10V	-	9.9	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	11.7	-	nC
Drain-Source Diode Characteristics			<u>.</u>			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	-20	А
Reverse Recovery Time	trr	TJ = 25°C, IF = -20A	-	-	40	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	-	120	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

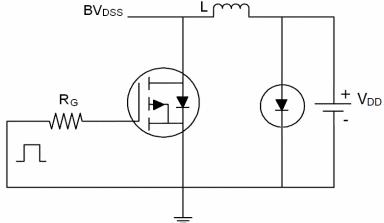
3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

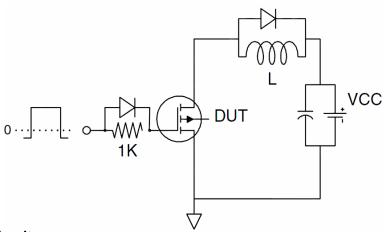
5. EAS condition: Tj=25 $^\circ\!\!\mathrm{C}$,V_DD=-30V,VG=-10V,L=0.5mH,Rg=25 Ω



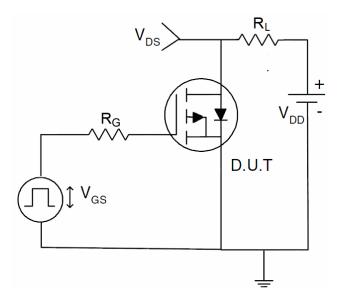
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

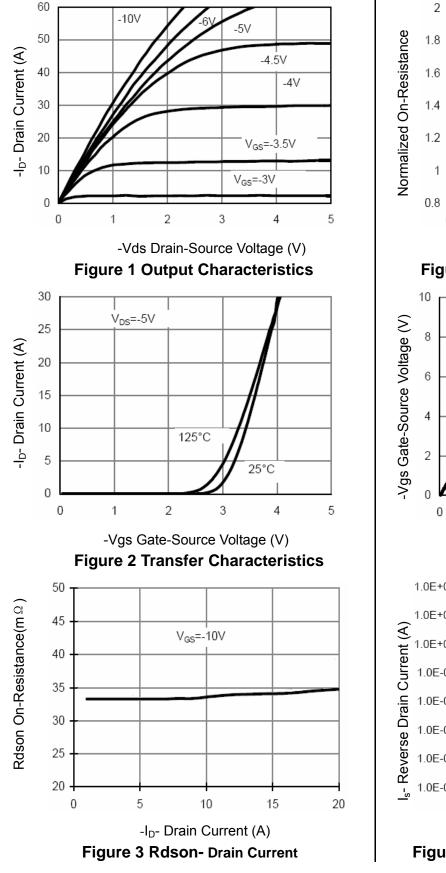


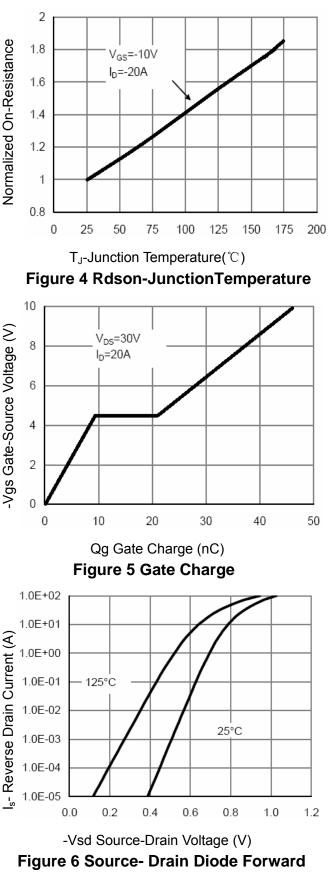
3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

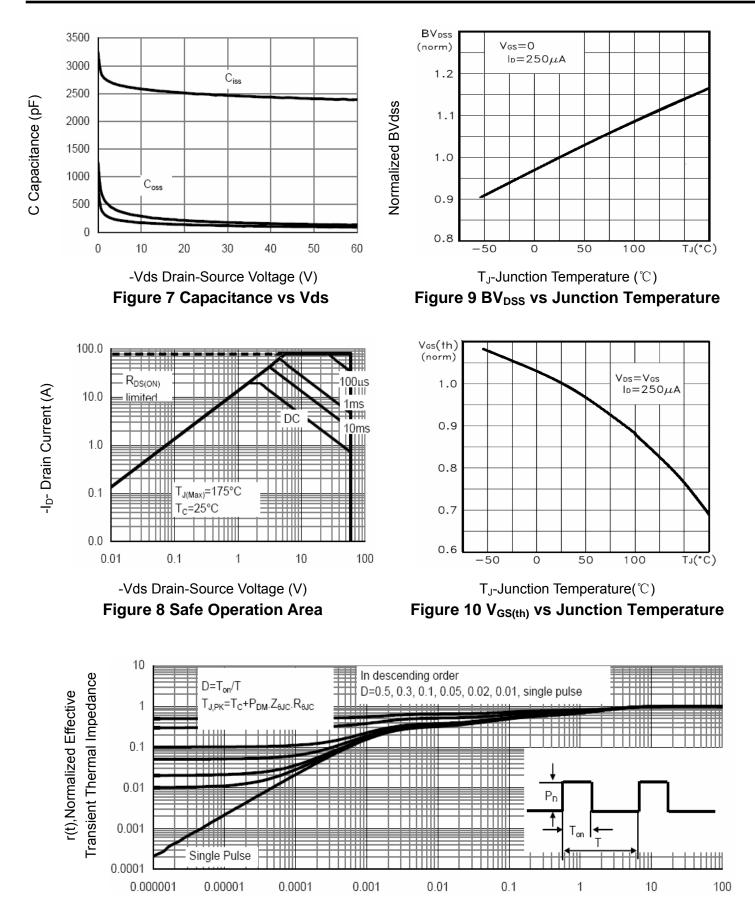






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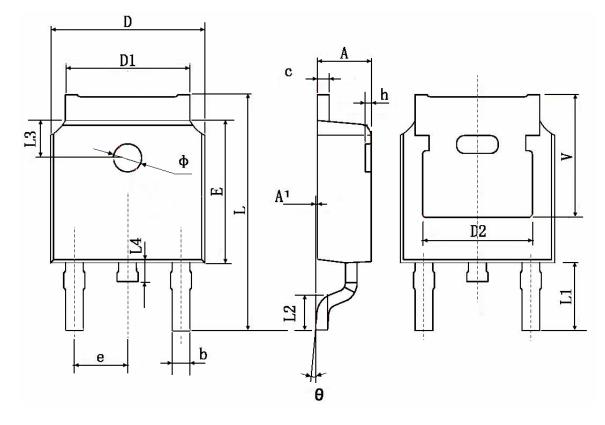
NCE60P20K



Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830 TYP.		0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350 TYP.		0.211 TYP.		



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